

CBR-SMD RF COG, Ceramic, 3.9 pF, +/-0.1 pF, 50 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0402



Dimensions	
Chip Size	0402
L	1mm +/-0.05mm
W	0.5mm +/-0.05mm
T	0.5mm +/-0.05mm
B	0.25mm +0.05/-0.1mm

Packaging Specifications	
Packaging:	T&R, 180mm, Plastic Tape
Packaging Quantity:	10000

General Information	
Series:	CBR-SMD RF COG
Style:	SMD Chip
Description:	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features:	Ultra High Q, Low ESR, Class I
RoHS:	Yes
Termination:	Tin
Marking:	No
AEC-Q200:	No
Component Weight:	1400 ug
Notes:	Solder Reflow Only.
Shelf Life:	78 Weeks
MSL:	1

Specifications	
Capacitance:	3.9 pF
Capacitance Tolerance:	+/-0.1 pF
Voltage DC:	50 VDC
Dielectric Withstanding Voltage:	125 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	COG
Dissipation Factor:	0.209%
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	10 GOhms
Quality Factor:	478

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.